

EPTC 2018

Abstract Submission Guideline via ConfTool

Updated 2018-06-14

Abstract submission is two step process:

- Create ConfTool account
- Submit Abstract (please use [EPTC's abstract template](#))
- Please note that only the abstract is required currently
- Copy right forms are only required upon full manuscript submission when your paper is accepted

- Useful links
 - Link: <https://www.conftool.net/eptc2018/>
 - http://www.conftool.net/en/user_documentation/instructions_for_authors.html#c470
 - Abstract template [https://www.eptc-ieee.net/uploads/exhibitors-pdf/5b04cfd6b7cc Abstract template 2018.doc](https://www.eptc-ieee.net/uploads/exhibitors-pdf/5b04cfd6b7cc_Abstract_template_2018.doc)

Create ConfTool Account

- You can skip this process if you already have an account with ConfTool



19th Electronics Packaging Technology Conference
6th - 9th Dec Grand Copthorne Waterfront Hotel, Singapore

IEEE CPMT Society's Flagship Conference in Asia Pacific Region

Register New | Conference Time: 31/Mar/2017 9:40:50 pm SGT

ConfTool Conference Administration

Log in to your account to **submit a contribution**, enter or view reviews and access the results of the reviewing process.

If you have not yet created a user account, please do so now.

Account Login

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On this page you can create a new user account for the ConfTool conference management system. All fields marked with an asterisk (*) must be filled in.

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Submit Abstract

- Once you have create an account and validated your email address, please login your ConfTool account and password
- You will be presented with the following page to submit your abstract

Overview English 12

Welcome, Amelie Amara!
You are logged in as user Amara.

You can select from the following options:

- Your Submissions**
Here you can submit new contributions and manage your submitted contributions.
You have submitted 5 contributions.
- Register as Participant**
Here you can register for conference participation.
- Browse Conference Agenda**
Overview and details of the event program.
- Show User Account Details**
Here you can access the personal data of your user account.
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Please sign out when you are finished to prevent unauthorized access to your account.
- Logout and Return to the Main Website**
Sign out and return to the website "15thSample ConfTool Conference".



Submit Contribution

You may now submit a contribution for this event. Please select a submission conference topic below. Remember to click the "Complete Submission" button on the second screen!

Abstracts are solicited to describe original and unpublished work. The abstract should be at least 500-750 words and it must clearly state the purpose, methodology, results (including data, drawings, graphs and photographs) and conclusion of the work.

Key references to prior publications and how the work enhances existing knowledge should be included in the abstract as well. Authors can choose between oral or interactive presentation. Accepted papers have to be registered and presented (oral & interactive) in the conference by the authors, then will be published in IEEE Xplore.

All submissions must be in English.

Advanced Packaging
Advanced Flip-chip, 2.5D & 3D, PoP, embedded passives & actives on substrates, System in Packaging, embedded chip packaging technologies,
Panel level packaging, RF, Microwave & Millimeter-wave, Power and Rugged Electronics Packaging etc.
Deadline: 15th Jun 2017, 11:59:59pm SGT, *Time left:* 76 days 2 hours

TSV/Wafer Level Packaging
Wafer level packaging (Fan in/Fan out), embedded chip packaging, 2.5D/3D integration, TSV, Silicon & Glass interposer, RDL, bumping technologies, etc.
Deadline: 15th Jun 2017, 11:59:59pm SGT, *Time left:* 76 days 2 hours

Interconnection Technologies
Au/Ag/Cu/Al wire-bond / wedge bond technology, flip-chip & Cu pillar, solder alternatives (ICP, ACP, ACF, NCP, ICA), Cu to Cu, wafer level bonding & die attachment (Pb-free) etc.
Deadline: 15th Jun 2017, 11:59:59pm SGT, *Time left:* 76 days 2 hours

Emerging Technologies
Packaging technologies for MEMS, biomedical, optoelectronics, Internet of things, photo voltaic, printed electronics, wearable electronics, Photonics, LED, etc.
Deadline: 15th Jun 2017, 11:59:59pm SGT, *Time left:* 76 days 2 hours

Please select your topic, and follow the instruction for author and file upload

Fill up the authors's information and file upload

Submission type

Information on Author(s)

* Author(s)	First & Middle Name/s	Last Name	E-Mail	Org. Index ?
1	Amelia	Hart	amelia.hart#hertz.net	
2				
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If the contribution has several authors from different organizations, please put an **index number** of the authors' organizations in the right column. The index numbers have to match the line numbers of the organizations below.
Several organizations per author may be separated by commas.

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* Title of Contribution	
* Abstract	

ConfTool will send email acknowledgment for abstract upload

Please use the abstract template found at the EPTC website
<https://www.eptc-ieee.net>